### INTEGRATED CIRCUITS

## DATA SHEET

# **74F86**Quad 2-input exclusive-OR gate

**Product specification** 

1990 Feb 09

IC15 Data Handbook





## **Quad 2-input Exclusive-OR gate**

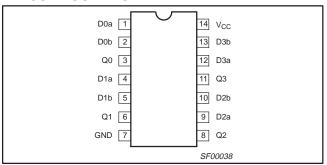
74F86

#### **FEATURE**

• Industrial temperature range available (-40°C to +85°C)

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F86	4.3ns	16.5mA

#### **PIN CONFIGURATION**



#### ORDERING INFORMATION

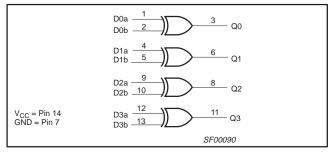
	ORDER CODE								
DESCRIPTION	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$ , $T_{amb} = 0^{\circ}C$ to +70°C	INDUSTRIAL RANGE $V_{CC}$ = 5V $\pm 10\%$ , $T_{amb}$ = $-40^{\circ}$ C to +85 $^{\circ}$ C	PKG DWG #						
14-pin plastic DIP	N74F86N	I74F86N	SOT27-1						
14-pin plastic SO	N74F86D	I74F86D	SOT108-1						

#### INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Dna, Dnb	Data inputs	1.0/1.0	20μA/0.6mA
Qn	Data output	50/33	1.0mA/20mA

#### NOTE:

#### **LOGIC DIAGRAM**



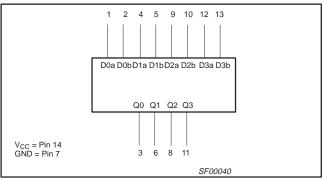
#### **FUNCTION TABLE**

INPL	JTS	OUTPUT
Dna	Dnb	Qn
L	L	L
L	Н	Н
Н	L	н
Н	Н	L

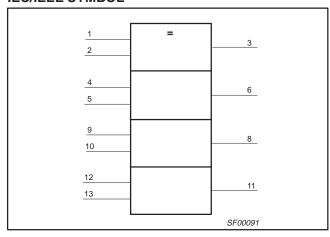
#### NOTES:

H = High voltage levelL = Low voltage level

#### **LOGIC SYMBOL**



#### **IEC/IEEE SYMBOL**



<sup>1.</sup> One (1.0) FAST unit load is defined as:  $20\mu A$  in the High state and 0.6mA in the Low state.

## Quad 2-input Exclusive-OR gate

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#### **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	_	RATING	UNIT
V <sub>CC</sub>	Supply voltage		-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage	-0.5 to +7.0	V	
I <sub>IN</sub>	Input current	−30 to +5	mA	
V <sub>OUT</sub>	Voltage applied to output in High output state		–0.5 to V <sub>CC</sub>	V
l <sub>OUT</sub>	Current applied to output in Low output state		40	mA
_	Operating free pir temperature reage	Commercial range	0 to +70	°C
T <sub>amb</sub>	Operating free-air temperature range	Industrial range	-40 to +85	°C
T <sub>sta</sub>	Storage temperature range		-65 to +150	°C

#### RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER			LIMITS		UNIT
STWIBOL	PARAMETER	MIN	NOM	MAX	UNII	
V <sub>CC</sub>	Supply voltage		4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage		2.0			V
V <sub>IL</sub>	Low-level input voltage				0.8	V
I <sub>IK</sub>	Input clamp current				-18	mA
I <sub>OH</sub>	High-level output current				-1	mA
I <sub>OL</sub>	Low-level output current				20	mA
т.	Operating free-air temperature range	Commercial range	0		+70	°C
lamb	Operating nee-all temperature range	Industrial range	-40		+85	°C

#### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDIT	IONS <sup>1</sup>		LIMITS		UNIT
					MIN	TYP <sup>2</sup>	MAX	
V	Lligh lavel output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V <sub>CC</sub>	2.5			V
V <sub>OH</sub>	High-level output voltage		$V_{IH} = MIN, I_{OH} = MAX$	2.7	3.4		V	
V	Low lovel output voltage		V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX	±10%V <sub>CC</sub>		0.30	0.50	V
V <sub>OL</sub>	Low-level output voltage		$V_{IH} = MIN, I_{OL} = MAX$		0.30	0.50	V	
V <sub>IK</sub>	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$		-0.73	-1.2	V	
l <sub>l</sub>	Input current at maximum input vol	tage	$V_{CC} = MAX, V_I = 7.0V$			100	μΑ	
I <sub>IH</sub>	High-level input current		$V_{CC} = MAX, V_I = 2.7V$			20	μΑ	
I <sub>IL</sub>	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$				-0.6	mA
I <sub>OS</sub>	Short-circuit output current <sup>3</sup>		V <sub>CC</sub> = MAX		-60		-150	mA
I <sub>CC</sub>	Supply current (total)		V <sub>CC</sub> = MAX	D0a = GND, D0b = 4.5V		15	23	mA
		I <sub>CCL</sub>	V <sub>CC</sub> = MAX	$V_{IN} = 4.5V$		18	28	mA

#### NOTES:

- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- 2. All typical values are at  $V_{CC} = 5V$ ,  $T_{amb} = 25$ °C.

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<sup>3.</sup> Not more than one output should be shorted at a time. For testing I<sub>OS</sub>, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

## Quad 2-input Exclusive-OR gate

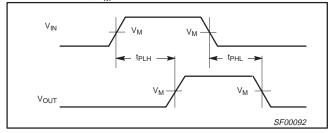
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#### **AC ELECTRICAL CHARACTERISTICS**

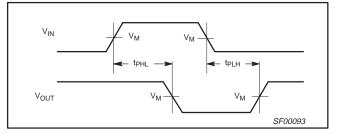
						LI	MITS			
SYMBOL	PARAMETER	TEST CONDITION	T <sub>an</sub> C	<sub>C</sub> = +5. <sub>nb</sub> = +25 <sub>L</sub> = 50p <sub>L</sub> = 500	5°C ∍F	V <sub>CC</sub> = +5. T <sub>amb</sub> = 0°C C <sub>L</sub> = R <sub>L</sub> =	50pF	V <sub>CC</sub> = +5. T <sub>amb</sub> = -40° C <sub>L</sub> = R <sub>L</sub> =	UNIT	
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay Dna or Dnb to Qn (other input Low)	Waveform 1	3.0 3.0	4.0 4.2	5.5 5.5	3.0 3.0	6.5 6.5	3.0 2.5	7.0 8.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay Dna or Dnb to Qn (other input High)	Waveform 2	3.5 3.0	5.3 4.7	7.0 6.5	3.5 3.0	8.0 7.5	3.5 3.0	10.0 8.0	ns

#### **AC WAVEFORMS**

For all waveforms,  $V_M = 1.5V$ .

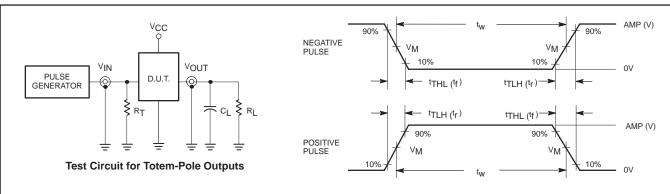


Waveform 1. Propagation Delay for Non-Inverting Outputs



Waveform 2. Propagation Delay for Inverting Outputs

#### **TEST CIRCUIT AND WAVEFORMS**



#### **DEFINITIONS:**

R<sub>L</sub> = Load resistor;

 $\begin{array}{lll} & \text{see AC ELECTRICAL CHARACTERISTICS for value.} \\ C_L & = & \text{Load capacitance includes jig and probe capacitance;} \\ & \text{see AC ELECTRICAL CHARACTERISTICS for value.} \\ \end{array}$ 

R<sub>T</sub> = Termination resistance should be equal to Z<sub>OUT</sub> of pulse generators.

#### Input Pulse Definition

family	INP	UT PU	LSE REQU	REMEN	TS	
lailily	amplitude	V <sub>M</sub>	rep. rate	t <sub>w</sub>	t <sub>TLH</sub>	t <sub>THL</sub>
74F	F 3.0V		1MHz	500ns	2.5ns	2.5ns

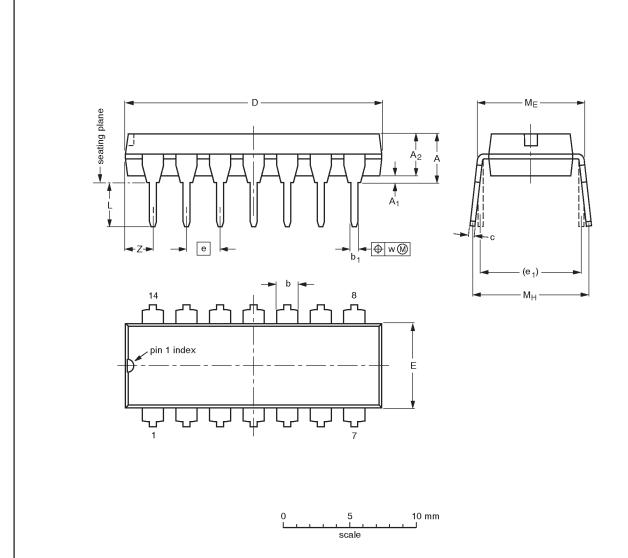
SF00006

## Quad 2-input exclusive-OR gate

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#### DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	ON IEC JI		EIAJ	PROJECTION	ISSUE DATE	
SOT27-1	050G04	MO-001AA			<del>92-11-17</del> 95-03-11	

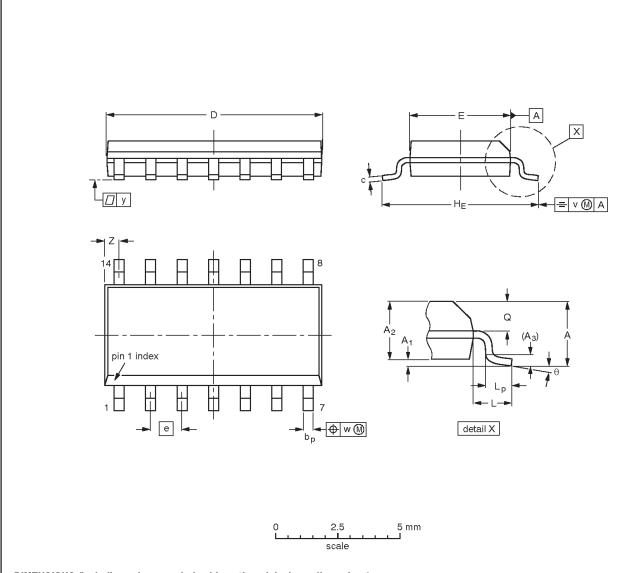
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## Quad 2-input exclusive-OR gate

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#### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	o°

#### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT108-1	076E06S	MS-012AB				<del>95-01-23</del> 97-05-22

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Philips Semiconductors Product specification

## Quad 2-input exclusive-OR gate

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**NOTES** 

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## Quad 2-input exclusive-OR gate

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#### Data sheet status

Data sheet status	Product status	Definition [1]	
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.	
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<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

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